TOSHIBA Multi-chip Device Silicon PNP Epitaxial Transistor , Field Effect Transistor Silicon N Channel MOS Type

TPCP8F01

Swtching Applications

Load Switch Applications

 Multi-chip discrete device; built-in PNP Transistor for main switch and N-ch MOS FET for drive

• High DC current gain: $h_{FE} = 200 \text{ to } 500 \text{ (IC} = -0.5 \text{ A)}$

(PNP Transistor)

• Low collector-emitter saturation: $V_{CE (sat)} = -0.19 \text{ V (max)}$

(PNP Transistor)

• High-speed switching: tf = 40 ns (typ.) (PNP Transistor)

Absolute Maximum Ratings (Ta = 25°C)

Transistor

| Characteristics | | Symbol | Rating | Unit | |
|-----------------------------|-------|-------------------------|--------|------|--|
| Collector-base voltage | | V _{CBO} | -30 | ٧ | |
| Collector-emitter voltage | | V _{CEO} | -20 | ٧ | |
| Emitter-base voltage | | V _{EBO} | -7 | V | |
| Collector current | DC | IC | -3.0 | Α | |
| | Pulse | I _{CP} | -5.0 | ζ | |
| Base current | | ΙΒ | -250 | mA | |
| Collector power dissipation | | P _C (Note 1) | 1.0 | W | |
| Junction temperature | | Tj | 150 | °C | |

Unit: mm ♦ 0.05M A 0.475 B 0.05M B A 0.8±0.05 S 0.025 S 0.17±0.02 $0.28^{+0.1}_{-0.11}$ $1.12^{+0.13}_{-0.12}$ $1.12_{\,-0.12}^{\,+0.13}$ $0.28^{+0.1}_{-0.11}$ 1.Source 5.Emitter 2.Collector 6.Base 4.Collector **JEDEC** JEITA **TOSHIBA** 2-3V1B

Weight: 0.017g (Typ.)

MOS FET

| Characteristics | | Symbol | Rating | Unit | |
|----------------------|-------|------------------|--------|------|--|
| Drain-source voltage | | V_{DSS} | 20 | V | |
| Gate-source voltage | | V _{GSS} | ±10 | V | |
| Drain current | DC | ID | 100 | mA | |
| | Pulse | I _{DP} | 200 | IIIA | |
| Channel temperature | | Tj | 150 | °C | |

Note 1: Mounted on FR4 board (glass epoxy, 1.6mm thick, Cu area: 645mm²)

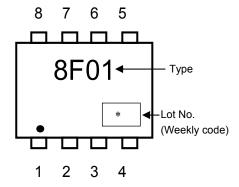
Note 2: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Common Absolute Maximum Rating (Ta = 25°C)

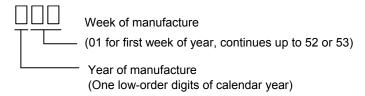
| Characteristics | Symbol | Rating | Unit |
|---------------------------|------------------|------------|------|
| Storage temperature range | T _{stg} | -55 to 150 | °C |

Figure 2 Marking (Note 3)



Note 3 : Black round marking " • " located on the left lower side of parts number marking "8F01" indicates terminal No.1

* Weekly code: (Three digits)



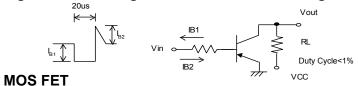
2

Electrical Characteristics (Ta = 25°C)

Transistor

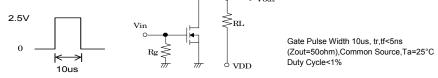
| Characteristics | | Symbol | Test Condition | Min | Тур. | Max | Unit |
|--------------------------------------|--------------|-----------------------|--|-----|------|-------|------|
| Collector cut-off current | | I _{CBO} | $V_{CB} = -30 \text{ V}, I_{E} = 0$ | _ | _ | -100 | nA |
| Emitter cut-off current | | I _{EBO} | $V_{EB} = -7 \text{ V}, I_{C} = 0$ | _ | _ | -100 | nA |
| Collector-emitter breakdown voltage | | V (BR) CEO | $I_C = -10 \text{ mA}, I_B = 0$ | -20 | _ | _ | V |
| DC current gain | | h _{FE} (1) | $V_{CE} = -2 \text{ V}, I_{C} = -0.5 \text{ A}$ | 200 | _ | 500 | |
| | | h _{FE} (2) | V _{CE} = -2 V, I _C = -1.6 A | 100 | _ | _ | |
| Collector-emitter saturation voltage | | V _{CE} (sat) | $I_C = -1.6 \text{ A}, I_B = -53 \text{ mA}$ | _ | _ | -0.19 | V |
| Base-emitter saturation voltage | | V _{BE} (sat) | $I_C = -1.6 \text{ A}, I_B = -53 \text{ mA}$ | _ | _ | -1.10 | V |
| Collector Output Capacitance | | C _{ob} | V _{CB} = -10 V, I _E = 0, f = 1MHz | _ | 28 | _ | pF |
| Switching time | Rise time | t _r | See Figure 3 circuit diagram $ \begin{array}{l} \text{V}_{CC} \simeq -12 \text{ V}, \text{ R}_L = 7.5 \Omega \\ -\text{I}_{B1} = \text{I}_{B2} = -53 \text{ mA} \end{array} $ | _ | 70 | _ | |
| | Storage time | t _{stg} | | _ | 150 | _ | ns |
| | Fall time | t _f | | _ | 40 | _ | |

Figure 3. Switching Time Test Circuit & Timing Chart



| Characteristics | | Symbol | Test Condition | Min | Тур. | Max | Unit |
|------------------------------|---------------|---------------------|---|-----|------|-----|------|
| Gate leakage curre | nt | I _{GSS} | $V_{GS} = -10 \text{ V}, V_{DS} = 0$ | _ | _ | ±1 | μΑ |
| Drain-source break | down voltage | V (BR) DSS | $I_D = 0.1 \text{ mA}, V_{GS} = 0$ | 20 | _ | _ | V |
| Drain cut-off curren | t | I _{DSS} | V _{DS} = 20 V, V _{GS} = 0 | _ | _ | 1 | μΑ |
| Gate Threshold vol | tage | V _{th} | $V_{DS} = 3 \text{ V}, I_D = 0.1 \text{ mA}$ | 0.6 | _ | 1.1 | V |
| Forward Transfer A | dmittance | Y _{fs} | $V_{DS} = 3 \text{ V}, I_D = 10 \text{ mA}$ | 40 | _ | _ | mS |
| Drain-source ON resistance | | R _{DS(ON)} | I _D = 10 mA, V _{GS} = 4.0 V | _ | 1.5 | 3 | Ω |
| | | | I _D = 10 mA, V _{GS} = 2.5 V | _ | 2.2 | 4 | |
| | | | I _D = 1 mA, V _{GS} = 1.5 V | _ | 5.2 | 15 | |
| Input capacitance | | C _{iss} | V _{DS} = 3 V, V _{GS} = 0, f = 1 MHz | _ | 9.3 | _ | pF |
| Reverse transfer capacitance | | C _{rss} | | _ | 4.5 | _ | |
| Output capacitance | | Coss | | _ | 9.8 | _ | |
| Switching time | Turn-on time | t _{on} | $V_{DD} \simeq -3 \text{ V, R}_L = 300 \Omega$ $V_{GS} = 0 \text{ to } 2.5 \text{ V}$ | _ | 70 | _ | - ns |
| | Turn-off time | t _{off} | | _ | 125 | _ | |

Figure 4. Switching Time Test Circuit & Timing Chart

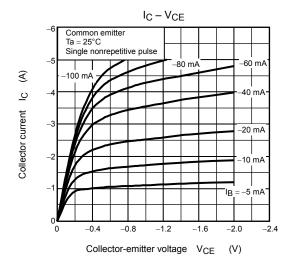


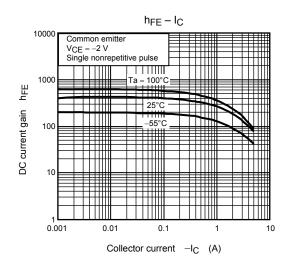
Precautions

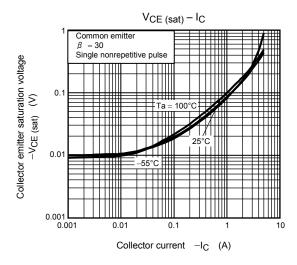
 V_{th} can be expressed as voltage between gate and source when low operating current value is I_D = 100 μ A for this product. For normal switching operation, $V_{GS(ON)}$ requires higher voltage than V_{th} snd $V_{GS(OFF)}$ requires lower voltage than V_{th} . (relationship can be established as follows: $V_{GS(OFF)} < V_{th} < V_{GS(ON)}$) Please take this into consideration for using the device.

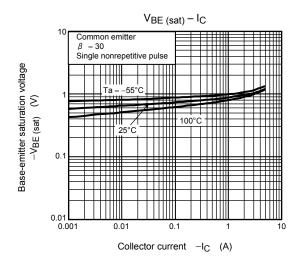
VGS recommended voltage of 2.5V or higher to turn on this product.

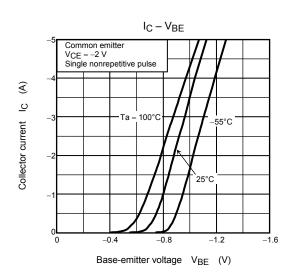
PNP

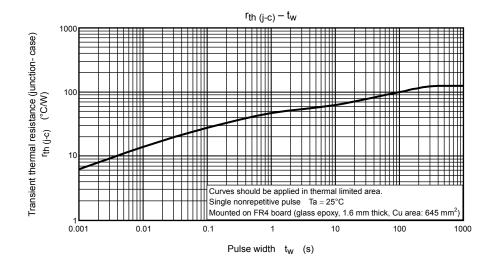


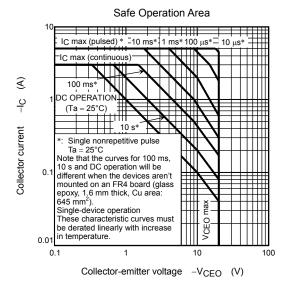




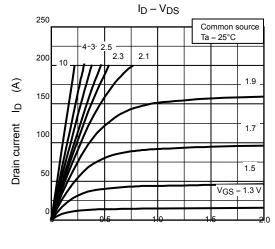


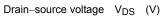


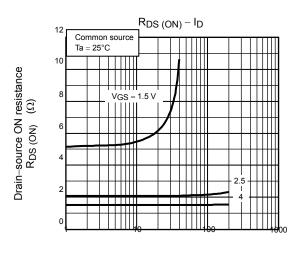




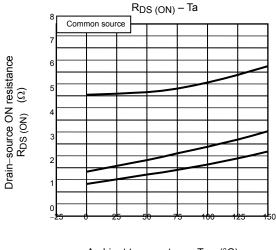
Nch-MOS



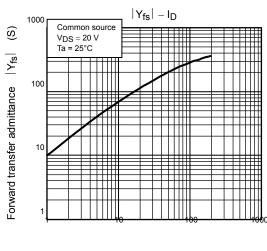




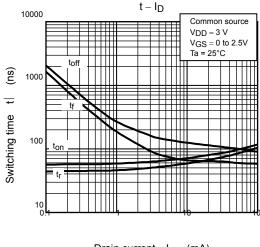
Drain current I_D (A)



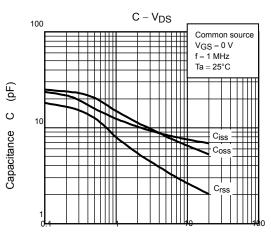
Ambient temperature Ta (°C)



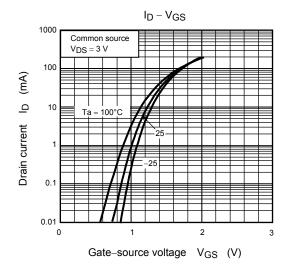
Drain current I_D (A)

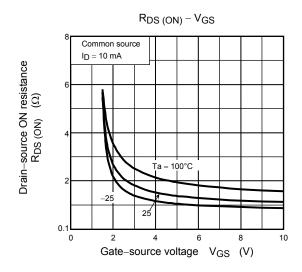


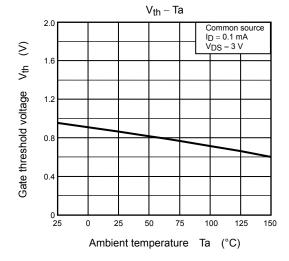
Drain current I_D (mA)

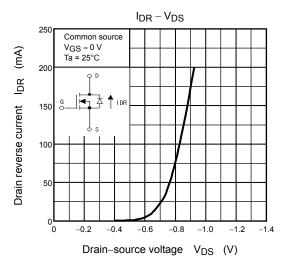


Drain-source voltage V_{DS} (V)









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20070701-EN

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